

L Numb r	Hits	S arch T xt	DB	Time stamp
1	246	430/198	USPAT; US-PGPUB; DERWENT	2003/11/15 17:09
2	1998	(430/311).CCLS.	USPAT; US-PGPUB; DERWENT	2003/11/15 17:09
3	1623	(430/330).CCLS.	USPAT; US-PGPUB; DERWENT	2003/11/15 17:09
4	31	((430/330).CCLS.) and (glass adj substrate)) and (conductor or " conductive paste")	USPAT; US-PGPUB; DERWENT	2003/11/15 17:10
5	15	((430/322).CCLS.) and (glass adj substrate)) and (conductor or " conductive paste")	USPAT; US-PGPUB; DERWENT	2003/11/15 17:10
7	118	((174/250).CCLS.) and cross\$section	USPAT; US-PGPUB; DERWENT	2003/11/15 17:11
8	291	((conductor or wir\$4 or line or resistor) near pattern) and (corner same stress)	USPAT; US-PGPUB; DERWENT	2003/11/15 17:12
6	162	((430/322).CCLS.) and (glass adj substrate)	USPAT; US-PGPUB; DERWENT	2003/11/15 17:21
9	49	((438/610,669).CCLS.) and (sinter\$4 or calcin\$4 or burn\$3)	USPAT; US-PGPUB; DERWENT	2003/11/15 17:33